

DWDM-XFP-31.12-100-C

Cisco® DWDM-XFP-31.12 Compatible TAA 10GBase-DWDM XFP Transceiver 100GHz (SMF, 1531.12nm, 100km, LC, DOM)

Features:

- INF-8077i Compliance
- Duplex LC Connector
- Single-mode Fiber
- Commercial Temperature 0 to 70 Celsius
- Hot Pluggable
- Metal with Lower EMI
- Excellent ESD Protection
- RoHS Compliant and Lead Free



Applications:

- 10x Gigabit Ethernet over DWDM
- 8x/10x Fibre Channel
- Access, Metro and Enterprise

Product Description

This Cisco® DWDM-XFP-31.12 compatible XFP transceiver provides 10GBase-DWDM throughput up to 100km over single-mode fiber (SMF) using a wavelength of 1531.12nm via an LC connector. It can operate at temperatures between 0 and 70C. Our transceiver is built to meet or exceed OEM specifications and is guaranteed to be 100% compatible with Cisco®. It has been programmed, uniquely serialized, and tested for data-traffic and application to ensure that it will initialize and perform identically. All of our transceivers comply with Multi-Source Agreement (MSA) standards to provide seamless network integration. Additional product features include Digital Optical Monitoring (DOM) support which allows access to real-time operating parameters. This transceiver is Trade Agreements Act (TAA) compliant. We stand behind the quality of our products and proudly offer a limited lifetime warranty.

ProLabs' transceivers are RoHS compliant and lead-free.

TAA refers to the Trade Agreements Act (19 U.S.C. & 2501-2581), which is intended to foster fair and open international trade. TAA requires that the U.S. Government may acquire only "U.S.-made or designated country end products.")



Regulatory Compliance

- ESD to the Electrical PINs: compatible with MIL-STD-883E Method 3015.4
- ESD to the LC Receptacle: compatible with IEC 61000-4-3
- EMI/EMC compatible with FCC Part 15 Subpart B Rules, EN55022:2010
- Laser Eye Safety compatible with FDA 21CFR, EN60950-1& EN (IEC) 60825-1,2
- RoHS compliant with EU RoHS 2.0 directive 2015/863/EU

Wavelength Guide (100GHz ITU-T Channel)

Channel #	Frequency (THz)	Center Wavelength (nm)
34	193.4	1550.12
35	193.5	1549.32
36	193.6	1548.51
37	193.7	1547.72
38	193.8	1546.92
39	193.9	1546.12
40	194.0	1545.32
41	194.1	1544.53
42	194.2	1543.73
43	194.3	1542.94
44	194.4	1542.14
45	194.5	1541.35
46	194.6	1540.56
47	194.7	1539.77
48	194.8	1538.98
49	194.9	1538.19
50	195.0	1537.40
51	195.1	1536.61
52	195.2	1535.82
53	195.3	1535.04
54	195.4	1534.25
55	195.5	1533.47
56	195.6	1532.68
57	195.7	1531.90
58	195.8	1531.12
59	195.9	1530.33
60	196.0	1529.55
61	196.1	1528.77

Absolute Maximum Ratings

Parameter	Symbol	Min.	Max.	Unit
Maximum Supply Voltage	V _{cc3}	-0.5	3.6	V
	V _{cc5}	-0.5	6	V
Storage Temperature	T _S	-40	85	°C
Operating Temperature	T _O	0	70	°C
Operating Humidity	RH	5	95	%
Receiver power	R _{MAX}		-7	dBm
Maximum bitrate	B _{max}	9.95	11.3	Gbps

Electrical Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Notes
Power Supply Voltage	V _{cc3}	3.135	3.30	3.465	V	
	V _{cc5}	4.75	5.0	5.25	V	
Power Supply Current	I _{cc3}			750	mA	
Power Supply Current	I _{cc5}			500	mA	
Power Dissipation	P _D			3500	mW	
Transmitter						
Differential data input swing	V _{in,pp}	120		1000	mVp-p	
Input differential impedance	Z _{in}		100		Ω	
Tx_Disable, P_Down/RST	V _{IH}	2.0		V _{CC3} +0.3	V	
	V _{IL}	-0.3		0.8	V	
Transmit Disable Assert Time				10	us	
Receiver						
Differential data output swing	V _{out, pp}	340		850	mVp-p	1
Output differential impedance	Z _{in}		100		Ω	
Data Output Rise Time, Fall Time	t _r , t _f	24			ps	2
Rx_LOS, Mod_NR, Interrupt	V _{OH}	V _{CCHOST} -0.5		V _{CCHOST} +0.3	V	3
	V _{OL}	0		0.4	V	3

Notes:

1. Internally AC coupled but requires an external 100Ω differential termination.
2. 20–80%.
3. Loss of Signal is an open collector output. Should be pulled up with a 4.7kΩ-10kΩ resistor on the host board.

Optical Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Notes
Transmitter						
Launch Average Optical Power	P _O	1		+4	dBm	1
Center Wavelength Range	λ _c	1528.77		1563.86	nm	
Center Wavelength Spacing			100		GHz	
Center Wavelength Tolerance	Δλ _c	-100		100	pm	
Extinction Ratio	EX	9			dB	2
Spectral Width (-20dB)	Δλ			0.3	nm	
Side Mode Suppression Ratio	SMSR	30			dB	
Average Optical Power (Laser Off)	P _{OFF}			-30	dBm	1
Eye Diagram	ITU-T G.691 SDH STM-64 L-64.2 compatible					2
Receiver						
Center Wavelength	λ _c	1528		1565	nm	
Receiver Sensitivity @ 9.953Gb/s	S			-26.0	dBm	3
Receiver Overload (P _{avg})	P _{OL}	-7.0			dBm	3
Optical Return Loss	ORL	27			dB	
LOS De-Assert	LOS _D			-27	dBm	
LOS Assert	LOS _A	-38			dBm	
LOS Hysteresis		0.5			dB	

Notes:

1. The optical power is launched into 9/125μm SMF.
2. Measured with a PRBS 2³¹-1 test pattern @ 9.953Gbps.
3. Measured with worst ER; 1550nm; PRBS 2³¹-1 test pattern @ 9.953Gb/s, BER<10⁻¹².

Pin Descriptions

Pin	Symbol	Name/Descriptions	Ref.
1	GND	Module Ground	
2	Vee5	(not required)	
3	MOD_DESEL	Module De-select; When Held low allows the module to respond to 2-wire serial interface. LVTTTL-I	
4	/INTERRUPT	Interrupt; Indicates presence of an important condition which can be read via the 2-wire serial interface. LVTTTL-O	2
5	TX_DIS	Transmitter Disable. Logic1 indicates laser output disabled, LVTTTL-I	
6	VCC5	+5V Power Supply (Not required)	
7	GND	Module Ground	1
8	VCC3	+3.3V Power Supply	
9	VCC3	+3.3V Power Supply	
10	SCL	2-Wire Serial Interface Clock. LVTTTL-I	2
11	SDA	2-Wire Serial Interface Data Line. LVTTTL-I/O	2
12	MOD_Abs	Indicates Module is not present. Grounded in the Module. LVTTTL-O	2
13	MOD_NR	Module Not Ready; Indicating Module Operational Fault. Open-collector. LVTTTL-O	2
14	RX_LOS	Loss of Signal indication. Logic 1 indicates loss of Signal. Open-collector. LVTTTL-O	2
15	GND	Module Ground	1
16	GND	Module Ground	1
17	RD-	Receiver Inverted Data Output. CML-O	
18	RD+	Receiver Non-Inverted Data Output. CML-O	
19	GND	Module Ground	1
20	VCC2	+1.8V Power Supply (Not required).	3
21	P_DOWN/RST	Power down; When high, requires the module to limit power consumption to 1.5W or below. 2-Wire serial interface must be functional in the low power mode. LVTTTL-I Reset; The falling edge initiates a complete reset of the module including the 2-wire serial interface, equivalent to a power cycle. LVTTTL-I	
22	VCC2	+1.8V Power Supply (Not required)	3
23	GND	Module Ground	1
24	REFCLK+	Reference Clock (Not required)	
25	REFCLK-	Reference Clock (Not required)	
26	GND	Module Ground	1
27	GND	Module Ground	1
28	TD-	Transmitter Inverted Data Input. CML-I	
29	TD+	Transmitter Non-Inverted Data Input. CML-I	
30	GND	Module Ground	1

Notes:

1. Module ground pins GND are isolated from the module case and chassis ground within the module.
2. Open collector; should be pulled up with 4.7K-10Kohms to a voltage between 3.15V and 3.6V on the host board.
3. The pins are open within module.



Pin-out of connector Block on Host board

Recommended Circuit Schematic



Mechanical Specifications

Small Form Factor Pluggable (XFP) transceivers are compatible with the dimensions defined by the XFP Multi-Sourcing Agreement (MSA).



EEPROM Information

Management Interface

XFP 2-wire serial interface is specified in the Chapter 4 of the XFP MSA specification. The XFP 2-wire serial interface is used for serial ID, digital diagnostics, and certain control functions. The 2-wire serial interface is mandatory for all XFP modules. The 2-wire serial interface address of the XFP module is 1010000X(A0h). In order to access to multiple modules on the same 2-wire serial bus, the XFP has a MOD_DESEL(module deselect pin). This pin (which is pull high or deselected in the module) must be held low by the host to select of interest and allow communication over 2-wire serial interface. The module must not respond to or accept 2-wire serial bus instructions unless it is selected.

XFP Management Interface

XFP Management interface is specified in the Chapter 5 of the XFP MSA specification. The Figure 1 shows the structure of the memory map. The normal 256 Byte address space is divided into lower and upper blocks of 128 Bytes. The lower block of 128 Byte is always directly available and is used for the diagnostics and control functions that must be accessed repeatedly. Multiple blocks of memories are available in the upper 128 Bytes of the address space. These are individually addressed through a table select Byte which the user enters into a location in the lower address space. The upper address space tables are used for less frequently accessed functions and control space for future standards definition.

EEPROM memory map specific data field description is as below:



About ProLabs

Our extensive experience comes as standard. For over 20 years ProLabs has delivered optical connectivity solutions that give our customers freedom and choice through our ability to provide seamless interoperability. At the heart of our company is the ability to provide state-of-the-art optical transport and connectivity solutions that are compatible with more than 100 optical switching and transport platforms.

A Complete Portfolio of Network Solutions

ProLabs is focused on innovations in optical transport and connectivity. The combination of our knowledge of optics and networking equipment enables ProLabs to be your single source for optical transport and connectivity solutions from 100Mb to 1.6T while providing innovative solutions that increase network efficiency. We provide the optical connectivity expertise that is compatible with and enhances your switching and transport equipment.

The Trusted Partner

Customer service is our number one value. ProLabs has invested in people, labs and manufacturing capacity to ensure compatible products, and immediate answers to your questions. With Engineering and Manufacturing offices in the U.K. and U.S. augmented by field offices throughout the U.S., U.K. and Asia, ProLabs is able to be our customers best advocate 24 hours a day.



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